Record of Letter Ballot Review by TC Chapter for Procedural Review

Region/Locale: Japan

Global Technical Committee: Assembly & Packaging

TC Chapter Cochairs: Kazunori Kato/AiT, Masahiro Tsuriya/iNEMI

Standards staff: Chie Yanagisawa

	Scheduled in Background Statement	Actual
Date	07/24/2017	07/24/2017
Location	SEMI Japan office	SEMI Japan office

I. Document Number and Title

Document Number	Document Title
6158	Reapproval of SEMI G42-0996 (Reapproved 0811):
	Specification for Thermal Test Board Standardization
	for Measuring Junction-to-Ambient Thermal
	Resistance of Semiconductor Packages

II. Tally (Standards staff to fill in)

Voting Tally: As-cast tally after close of voting period

A minimum of 60% of the Voting Interests that have TC Members within the global technical committee that issued the Letter Ballot must return Votes. (*Regulations* ¶ 9.7.1.1)

Voting Tally (with example values):

Voting Interest:	Returned Votes		Distribution		Return Rate	
Letter Ballot	43	÷	68	=	63.2%	>=60%
Intercommittee Ballot	33					
Voting Interest Reject(s)	0		Total	l Vot	er with Rejects	0
Voting Interest Accept(s)	29					

III. Rejects

There is no reject vote on Ballot #6158.

IV. Other Technical Issues

There is no Other Technical Issue on Ballot #6158.

V. Comments

There is no comment on Ballot #6158.

V-(ii) Comments Created by handling Negative

There is no comment Created by handling Negative on Ballot #6158.

VI. Editorial Changes other than those dealt with in Section V.

There is no Editorial Changes other than those dealt with in Section V on Ballot #6158.

VII. Approval Conditions Check VII - (i). Approval Rate

APPROVAL CONDITION 1: All Negatives have been discussed and were withdrawn, found not related, found not persuasive, or addressed by a Technical Change. (*Regulations* ¶ 9.7.1.2)

APPROVAL CONDITION 2: At least 90% of the sum of valid Voting Interest Accept and Voting Interest Reject Votes must be Accept. (*Regulations* ¶ 9.7.1.3)

Note: If both approval conditions are not satisfied, the Document fails.

		Accepts		(Accepts + Valid Rejects)			
Approval Rate	=	29	1	29	=	100.0%	>=90%

VII – (ii) Approval Level (check one)

See § 9.7.2 of the *Regulations* for further information

X	The Letter Ballot meets the Letter Ballot Approval Conditions for the
	global technical committee
	The Letter Ballot the Letter Ballot Approval Conditions for the TC Chapter and a Ratification Ballot will be issued to verify Technical Changes

VIII. Safety Check
See § 15 of the *Regulations* for further information.

~	X	Th is s	This is not a Safety Document, when all safety-related information is removed, the Document is still technically sound and complete. (<i>Regulations</i> ¶ 8.7.1)							
Motion:			This is a Safety Document, when all safety-related information is removed, the Document is ot technically sound and complete. (<i>Regulations</i> ¶ 8.7.2)							
ľ			Safety Checklist (<i>Regulations</i> ¶ 15.3) is complete and has been included with the Document throughout the balloting process. (<i>Regulations</i> ¶¶ 15.1.2)							
I	Motion by/2nd by		y/2nd by	Kazunori Kato (AiT) / Hideki Suzuki (Shin-Etsu Polymer)						
	Discussion			None						
	Vote			6-0; Motion passed						

IX. Intellectual Property (IP) Check

Note: This Letter Ballot may cover all or part of a Standard or Safety Guideline. This IP check applies to the entire Standard or Safety Guideline. See § 16 of the Regulations for further information.

Х		TC Chapter meeting chair asked those participating, if they were aware of any potentially material nted technology or copyrighted items* in the Standard or Guideline. (<i>Regulations</i> ¶ 8.8.1)							
	X		otentially n righted iter		al patented technology or reproduction of e known.				
		Potentially material patented technology or reproduction of copyrighted items are known, but a Letter of Assurance (LOA) or copyright release letter for such items has been obtained or presented to the TC Chapter.							
		use	of such ma	teriaİs i	tented technology or reproduction of copyrights technically justified by the TC Chapter, but a of the item(s) has NOT been obtained or pres	an LOA or copyright			
	M		Ask ISC f	or spec	cial permission to publish.				
	MOTION		Quit activ	ity.					
	ON		Wait for L	OA for	patented technology or release of copyrighted	d items.			
	Moti	ion by	/2 nd by	Name (Company)/Name (Company)					
	Di	scus	sion	XXXX					
		Vote	9	XX-XX					
	F:.	aal Aa	otion		Motion Passed				
	r II	Final Action			Motion Failed				

^{*} Note: Such potentially material patented technology or copyrighted items might have become known since the Standard or Safety Guideline was last reviewed, or might become relevant due to this Letter Ballot.

X. Action for This Document

	X		ocument passed TC Chapter review as balloted and will be forwarded to the A&R SC for ural review.									
×			This Document passed TC Chapter review with editorial changes and will be forwarded to the A&R SC for procedural review.									
Motion		changes a	Document passed TC Chapter review with Technical Changes and with or without editorial nges and will be forwarded to the A&R SC for procedural review. A Ratification Ballot will be ed to verify the Technical Changes.									
		This Docu	This Document failed TC Chapter review and will be returned to the TF for rework.									
		This Docu	his Document failed TC Chapter review and work will be discontinued.									
N	lotic	on by/2nd by	Kazunori Kato (AiT) / Hideki Suzuki (Shin-Etsu Polymer)									
	Dis	cussion	None									
		Vote	6-0									
	Fins	al Action	X Motion passed									
	1 1110	ii Action	Motion failed									

Standards staff to record the result of the A&R procedural review here:

		Approved for publication
A&R		Approved pending for acceptance of the Ratification Ballot
		Not approved
	Re	eason: